

MOTOROLA MPC755 AND MPC745 POWERPC™ MICROPROCESSORS

MPC755 and MPC745 PowerPC microprocessors are high-performance, low-power, 32-bit implementations of the PowerPC Reduced Instruction Set Computer (RISC) architecture, specially enhanced for embedded applications. MPC755 and MPC745 microprocessors differ only in that the MPC755 features an enhanced, dedicated L2 cache interface with on-chip L2 tags. The MPC755 is a drop-in replacement for the award winning PowerPC 750™ microprocessor and is footprint and user software code compatible with the MPC7400 microprocessor with AltiVec™ technology. The MPC745 is a drop-in replacement for the PowerPC 740™ microprocessor and is also footprint and user software code compatible with the PowerPC 603e™ microprocessor. MPC755/745 microprocessors provide on-chip debug support and are fully JTAG-compliant.

Superscalar Microprocessor

MPC755 and MPC745 microprocessors are superscalar, capable of issuing three instructions per clock cycle (two instructions + branch) into six independent execution units:

- Two integer units
- Load/store unit
- Double-precision floating-point unit
- System register unit
- Branch processing unit

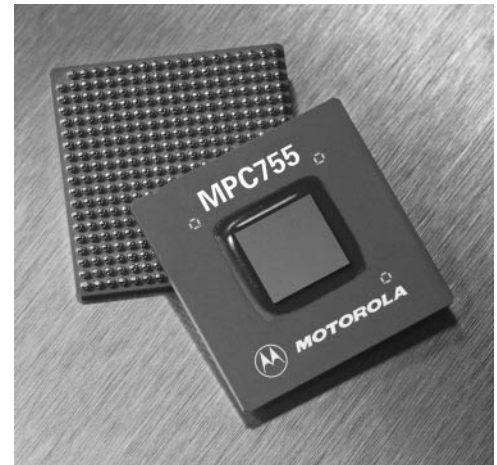
The ability to execute multiple instructions in parallel, to pipeline instructions, and the use of simple instructions with rapid execution times yields maximum efficiency and throughput for MPC755 and MPC745 systems.

Power Management

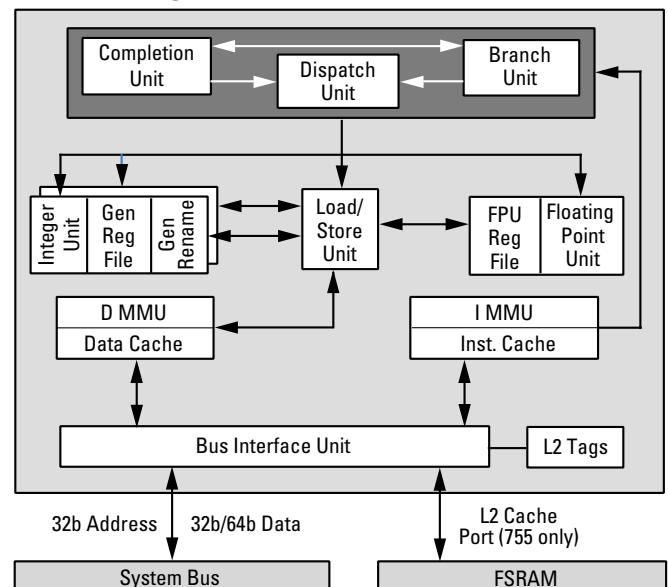
The MPC755 and MPC745 microprocessors feature a low-power 2.0-volt design with three power-saving user-programmable modes — doze, nap and sleep — which progressively reduce the power drawn by the processor.

These low-power microprocessors offer dynamic power management to selectively activate functional units as they are needed by the executing instructions. Both microprocessors also provide a thermal assist unit and instruction cache throttling for software-controllable thermal management.

Motorola MPC755 PowerPC Microprocessor



MPC755/745 Microprocessor Block Diagram



Cache and MMU Support

The MPC755/745 microprocessors have separate 32-Kbyte, physically-addressed instruction and data caches. Both caches can be locked in part or whole to provide storage of critical data, key performance algorithms, or code loops for fast response time. The MPC755 microprocessor's dedicated L2 cache interface with on-chip L2 tags (up to 1MB) features support for direct-mapped SRAM mode, physically-mapped SRAM mode, a fast (typically 1/2 core speed) interface to memory, instruction-only or data-only modes, and parity checking on both L2 address and data.

MPC755/745 microprocessors contain separate memory management units (MMUs) for instructions and data, supporting 4 Petabytes (2^{52}) of virtual memory and 4 Gigabytes (2^{32}) of physical memory. Both feature eight instruction block address translation (iBAT) and eight data block address translation (dBAT) registers. Access privileges and memory protection are controlled on block or page granularities. Large, 128-entry translation lookaside buffers (TLBs) provide efficient physical address translation and support for virtual-memory management on both page- and variable-sized blocks. Both hardware and software tablewalks are provided for the TLBs.

Flexible Bus Interface

MPC755/745 microprocessors have a 64-bit data bus with 32-bit mode and a 32-bit address bus. Support is included for burst, split and pipelined transactions. The interface provides snooping for data cache coherency. Both microprocessors maintain MEI coherency protocol in hardware, allowing access to system memory for additional caching bus masters, such as DMA devices.

Contact Information

Motorola offers user's manuals, application notes and sample code for all of its processors. In addition, local support for these products is also provided. This information can be found at:

<http://motorola.com/PowerPC/>

For all other inquiries about Motorola products, please contact the Motorola Customer Response Center at:

Phone: 800-521-6274 or

<http://motorola.com/semiconductors>

PowerPC 755/745 CPU Summary

	PowerPC 745 300-350 MHz	PowerPC 755 300-400 MHz
CPU Speeds – Internal	300 and 350 MHz	300, 350 and 400 MHz
CPU Bus Dividers	x3, x3.5, x4, x4.5, x5, x5.5, x6, x6.5, x7, x7.5, x8, x10	x3, x3.5, x4, x4.5, x5, x5.5, x6, x6.5, x7, x7.5, x8, x10
Bus Interface	32-bit/64-bit	32-bit/64-bit
Instructions per Clock	3 (2 + Branch)	3 (2 + Branch)
L1 Cache	32 Kbyte instruction 32 Kbyte data	32-Kbyte instruction 32-Kbyte data
L2 Cache	—	256, 512 Kbyte 1 Mbyte
Core-to-L2 Frequency	—	1:1, 1.5:1, 2:1, 2.5:1, 3:1
Typical/Maximum Power Dissipation	TBD	TBD
Die Size	51 mm ²	51 mm ²
Package	255 PBGA	360 PBGA
Process	0.22µ 5LM	0.22µ 5LM
Voltage	1.8/3.3V i/o, 2.0V internal	1.8/3.3V i/o, 2.0V internal
SPECint95 (estimated)	15.7 @ 350 MHz	18.1 @ 400 MHz
SPECfp95 (estimated)	11.6 @ 350 MHz	12.3 @ 400 MHz
Other Performance	641 MIPS @ 350 MHz	733 MIPS @ 400 MHz
Execution Units	Integer(2), Floating-Point, Branch, Load/Store, System Register	Integer(2), Floating-Point, Branch, Load/Store, System Register

PowerPC 1xx, 6xx and 7xx Part Number Key

XPC	755	B	PX	400	L	D
Product Code PPC Sample XPC XC qualified MPC Qualified	Series Device Number (106, 107, 603, 740, 745, 750, 755)	Part/Module Modifier A Alpha (original) B DGO process E 603 Enhanced Performance P Enhanced & Lower Voltage R 603e in HiP3 process	Package FE CQFP RX CBGA w/o lid PX PBGA w/o lid ZT PBGA w/ lid	Frequency 2-3 digits	Application Modifier Bus Ratio C 2:1 (106 only) D 5:2 (106 only) L Full spec all modes	Revision
					Application Relief R 105° T ext. temp. (-40° to 105°)	